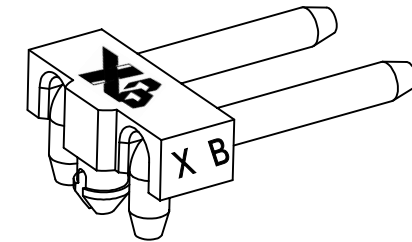
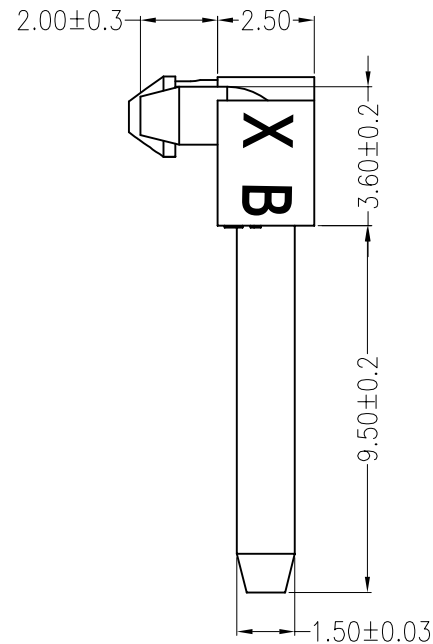
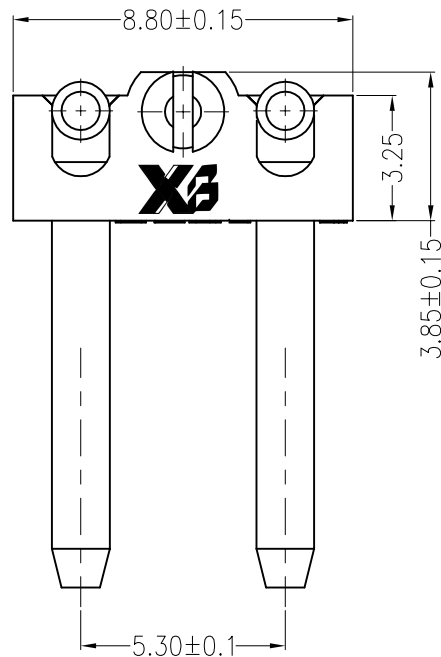


REV	DESCRIPTION	DESIGN	DATE
A0	Release	吴丹平	2016.05.13



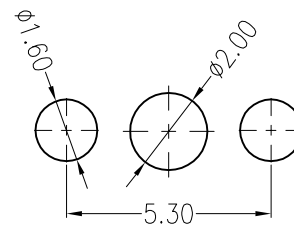
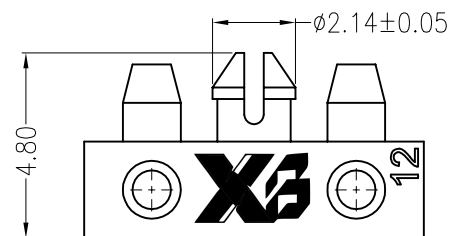
SUGGESTED PCB LAYOUT
(COMPONENT SIDE)

主要技术参数 Main Specifications

接触电阻 (Contact resistance): $\leq 20m\Omega$
绝缘电阻 (Insulation resistance): $\geq 1000M\Omega$
额定电压 (Rated voltage): 250V AC DC
额定电流 (Rated current): 3.0A AC DC
耐电压 (Withstand Voltage): 1000V AC/minute
温度范围 (Temperature Range): $-40^{\circ}C \sim +110^{\circ}C$

ORDER INFORMATION:

XB-L018B-02-B1MG-P-A			
PART No.			SPECIAL CODE: A=9.5X2.0
No. FOR CIRCUITS:			PACKAGING: P=PE
PLASTIC MATERIAL:			PLATING: G=Ni
B1M=PA46 (BEIGE)			



Board Layout
General Tolerance: ± 0.05

C				
B	CONTACT	2 PCS	Brass	Ni-plated
A	PEDESTAL	1 PCS	LCP	UL 94V-0, COLOR:BEIGE
ITEM	COMPONENT	Q'TY	MATERIAL	FINISH
XB 东莞市溪榜电子有限公司 Switch Connector DONG GUAN XI BANG ELECTRONICS CO., LTD				
X.±0.5	X.±5°	USE: CUSTOMER		PART NO.: L018B-02-B1MG-P-A
.X±0.3	.X±2°	APPD: 邵敬和		DWG NO.: GCCP-0286
.XX±0.25	.XX±1°	CHKD: 田峰		SCALE 1 : 1
--	--	DR: 蒋建银		SHEET 1 / 1
	UNITS: mm			